

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	BOILING TEMPERATURE DESIGN IN PUMPED MICROCHANNEL COOLING LOOPS						
Application Number :	10/643638						
Confirmation Number:	4432						
First Named Applicant:	Peng Zhou						
Attorney Docket Number:							
Art Unit:							
Examiner:							
Search string:	(5043797 or 5490117 or 5740013 or 5768104 or 5921087 or 6366467 or 6459581 or 6600220 or 6743664 or 20020121105 or 20030121274 or 20040040695 or 20040052049 or 20040089008 or 20040125561 or 20040160741 or 20040188069).pn						
Certification: This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:							
That no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of the information disclosure statement.							
US Patent Documents							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
FZ	1	5043797	1991-08-27	Lopes			
1	2	5490117	1996-02-06	Oda et al.			
	3	5740013	1998-04-14	Roesner et al.			
	4	5768104	1998-06-16	Salmonson et al.			
	5	5921087	1999-07-13	Bhatia et al.			
	6	6366467	2002-04-02	Patel et al.	B1		
	7	6459581	2002-10-01	Newton et al.	B1		
	8	6600220	2003-07-29	Barber et al.	B2		
FZ	9	6743664	2004-07-01	Liang et al.	B2		
US Published Applications							
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init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
FZ	1	20020121105	2002-09-05	McCarthy, Jr. et al.	A1		
	2	20030121274	2003-07-03	Wightman	A1		
	3	20040040695	2004-03-04	Chesser et al.	A1		
	4	20040052049	2004-03-18	Wu et al.	A1		
	5	20040089008	2004-05-13	Tilton et al.	A1		
	6	20040125561	2004-07-01	Gwin et al.	A1		
↓	7	20040160741	2004-08-19	Moss et al.	A1		
FZ	8	20040188069	2004-09-30	Tomioka et al.	A1		

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FZ	1	3361195	1968-01-02	A. Meyerhoff et al.			
	2	3771219	1973-11-13	Tuzi et al.			
	3	4644385	1987-02-17	Nakanishi et al.			
	4	4893174	1990-01-09	Yamada et al.			
	5	5386143	1995-01-31	Fitch			
	6	5658831	1997-08-19	Layton et al.			
	7	5675473	1997-10-07	McDunn et al.			
	8	6140860	2000-10-31	Sandhu et al.			
	9	6477045	2002-11-05	Wang	B1		
↓	10	6492200	2002-12-10	Park et al.	B1		
PZ	11	6578626	2003-06-17	Calaman et al.	B1		

Signature

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Philip Lee	7/28/2005